

# PTH And Micro Via-bility In A Single Bath.

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Yes We Can. With MacuSpec VF 100.



**Introducing MacuSpec VF 100 from MacDermid Electronics Solutions, the perfect way to simultaneously plate through holes and fill blind microvias in one bath.** Engineered specifically to increase productivity and ROI during the electrolytic copper metallization process, MacuSpec VF 100 eliminates an entire bath process to deliver the application flexibility you expect. Optimized for direct current and pulse plating, and for minimizing surface copper deposition, MacuSpec VF 100 is a drop-in solution that will increase bath life 400%.

When it comes to the most efficient way to plate through holes and fill blind microvias, count on the company that says "Yes We Can." MacDermid.



Metallization • Circuit Formation • Imaging Systems • Final Finishes • Interconnect • Emerging Technologies

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